



20V P-Channel Enhancement Mode MOSFET

Voltage

-20 V

Current

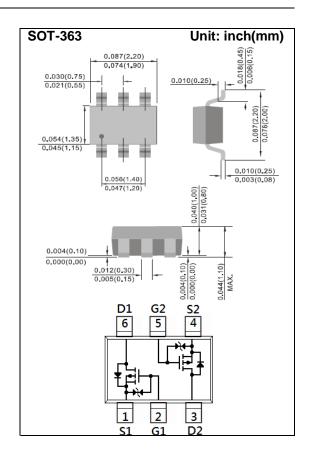
-500mA

Features

- Low Voltage Drive (1.2V).
- Advanced Trench Process Technology
- Specially Designed for Load switch, PWM Application, etc.
- ESD Protected
- Lead free in compliance with EU RoHS 2011/65/EU directive.
- Green molding compound as per IEC61249 Std. (Halogen Free)

Mechanical Data

- Case: SOT-363 Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0002 ounces, 0.006 grams
- Marking: T07



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V_{DS}	-20	V
Gate-Source Voltage		V_{GS}	<u>+</u> 10	V
Continuous Drain Current		I _D	-500	mA
Pulsed Drain Current (Note 4)		I _{DM}	-1000	mA
Power Dissipation	T _a =25°C	P _D	350	mW
	Derate above 25°C		2.8	mW/°C
Operating Junction and Storage Temperature Range		T_{J}, T_{STG}	-55~150	°C
Typical Thermal resistance				
- Junction to Ambient (Note 3)		$R_{\theta JA}$	357	°C/W





Electrical Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	V _{GS} =0V, I _D =-250uA	-20	-	ı	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=-250uA$	-0.3	-0.59	-1.0	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-500mA	-	0.85	1.2	Ω
		V _{GS} =-2.5V, I _D =-200mA	-	0.99	1.5	
		V _{GS} =-1.8V, I _D =-100mA	-	1.16	2.2	
		V _{GS} =-1.5V, I _D =-50mA	1	1.33	3.6	
		V _{GS} =-1.2V, I _D =-10mA	-	1.5	6.0	
Zero Gate Voltage Drain Current	I_{DSS}	V _{DS} =-16V, V _{GS} =0V	-	-	-1	uA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 8V, V_{DS}=0V$	-	<u>+</u> 2	<u>+</u> 10	uA
Dynamic (Note 5)						
Total Gate Charge	Q_g	V_{DS} =-10V, I_{D} =-500mA, V_{GS} =-4.5V (Note 1,2)	-	1.4	-	nC
Gate-Source Charge	Q_gs		-	0.19	-	
Gate-Drain Charge	Q_gd		-	0.2	-	
Input Capacitance	Ciss	.,	-	38	-	pF
Output Capacitance	Coss	V_{DS} =-10V, V_{GS} =0V, f =1.0MHZ	-	15	-	
Reverse Transfer Capacitance	Crss	I=1.0IVII IZ	-	9	-	
Turn-On Delay Time	td _(on)	\/ 10\/ 500m \	-	7.2	-	ns
Turn-On Rise Time	tr	V_{DD} =-10V, I_{D} =-500mA,	-	21	-	
Turn-Off Delay Time	td _(off)	V_{GS} =-4.5V, R_{G} =6 $\Omega^{\text{(Note 1,2)}}$	-	85	-	
Turn-Off Fall Time	tf	NG=022	-	116	-	
Drain-Source Diode						
Maximum Continuous Drain-Source	I _S			-	-500	mA
Diode Forward Current	'5					1117 (
Diode Forward Voltage	V_{SD}	I _S =-500mA, V _{GS} =0V	-	-0.93	-1.3	V

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. R_{OJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

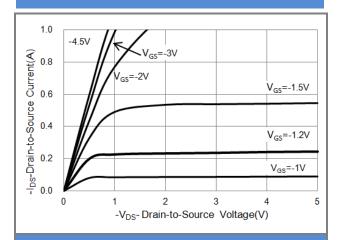


Fig.1 On-Region Characteristics

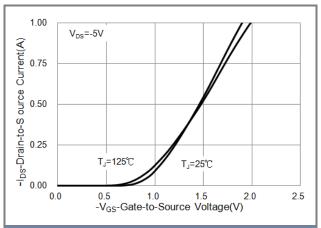


Fig.2 Transfer Characteristics

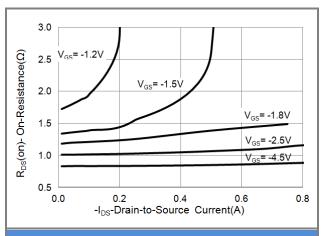


Fig.3 On-Resistance vs. Drain Current

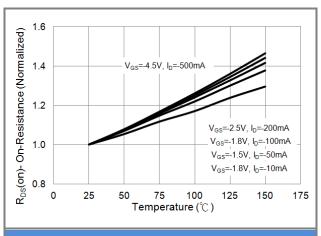


Fig.4 On-Resistance vs. Junction temperature

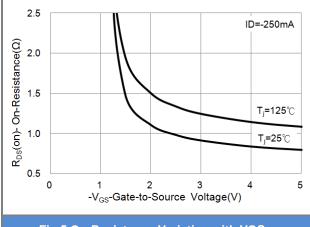


Fig.5 On-Resistance Variation with VGS.

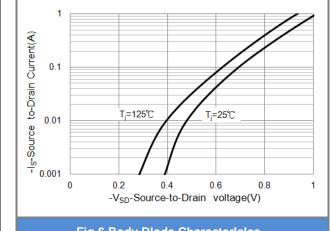


Fig.6 Body Dlode CharacterIslcs





TYPICAL CHARACTERISTIC CURVES

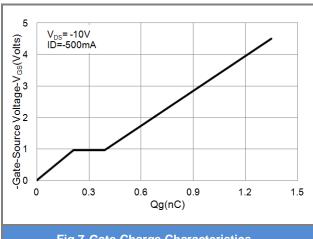


Fig.7 Gate-Charge Characteristics

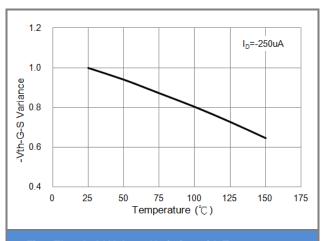


Fig.8 Threshold Voltage Variation with Temperature.

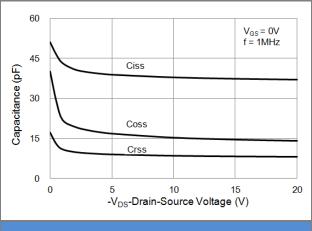


Fig.9 Capacitance vs. Drain-Source Voltage.

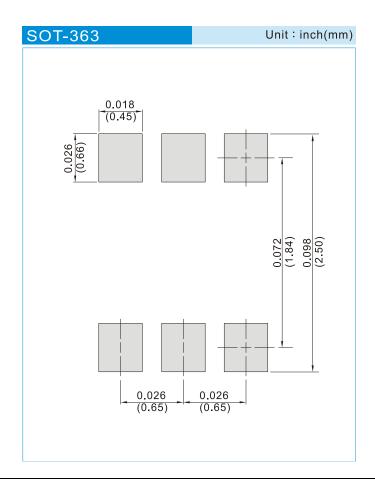




PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing type	Marking	Version
PJT7807_R1_00001	SOT-363	3K pcs / 7" reel	T07	Halogen free
PJT7807_R2_00001	SOT-363	10K pcs / 13" reel	T07	Halogen free

MOUNTING PAD LAYOUT







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